SPECIAL TOPIC — Amorphous physics and materials

LaGa-based bulk metallic glasses*

Lin-Zhi Zhao(赵林志), Rong-Jie Xue(薛荣洁), Wei-Hua Wang(汪卫华), and Hai-Yang Bai(白海洋)[†]

Institute of Physics, Chinese Academy of Sciences, Beijing 100190, China

(Received 14 November 2016; revised manuscript received 19 December 2016; published online 23 December 2016)

We report the formation of LaGa-based bulk metallic glasses. Ternary La–Ga–Cu glassy rods of 2–3 mm in diameter can be easily formed in a wide composition range by the conventional copper mold casting method. With minor addition of extra elements such as Co, Ni, Fe, Nb, Y, and Zr, the critical diameter of the full glassy rods of the La–Ga–Cu matrix can be markedly enhanced to at least 5 mm. The characteristics and properties of these new LaGa-based bulk metallic glasses with excellent glass formation ability and low glass transition temperature are model systems for fundamental issues investigation and could have some potential applications in micromachining field.

Keywords: bulk metallic glasses, glass forming ability, La–Ga–Cu alloys

PACS: 81.05.Kf, 64.70.pe, 62.65.+k, 61.43.Dq

DOI: 10.1088/1674-1056/26/1/018106

1. Introduction

Bulk metallic glasses (BMGs) are considered to be useful in a wide range of potential applications because their unique properties, including high strength, large elastic strain limit, high hardness, and good soft magnetic properties, which have attracted more and more attention.^[1–4] In the past few decades, a lot of glass-forming alloys with excellent glass-forming abilities have been successfully developed in Zr-,^[5,6] Pd-,^[7,8] Fe-,^[9,10] Ni-,^[11,12] Ti-,^[13] Cu-,^[14,15] Al-,^[16] Mg-,^[17] Cr-,^[18] U-,^[19] and rare earth (RE)-based^[20–33] systems, which has significantly broadened the promise of amorphous alloys.

Recently, with the development of the imprinting, embossing, and molding techniques using the viscous flow workability to make micro- and nano-devices from BMGs,^[34] intensive interest has been focused on developing BMGs with low glass transition temperature (T_g) , high glass-forming ability (GFA), wide supercooled liquid region ($\Delta T_{\rm x} = T_{\rm x} - T_{\rm g}$, $T_{\rm x}$ represents the crystallization temperature), high stability, and good mechanical properties. Besides, BMGs with lower $T_{\rm g}$ can provide a model system to investigate the slow dynamic and flow behaviors near room temperature of metallic amorphous. Recently, Ce-,^[20-22] Yb-,^[31] Sr-,^[35,36] CaLi-,^[37] Zn-,^[38] and Au-based^[39] BMGs with an exceptionally low $T_{\rm g}$ close to room temperature have been developed. However, these MGs with low $T_{\rm g}$ are too expensive or easily oxidized or react with the water quickly. So it is necessary to develop some new low cost BMGs with strong oxidation resistance, high corrosion resistance, and low T_{g} .

Gallium (Ga) is an element with low density (5.904 g/cm³), low elastic moduli (its Young's modulus is 9.8 GPa), low melting point (303 K), and strong oxidation resistance. Considering the similarities of atomic radius and atomic electronic negativity between Al and Ga elements, the

Ga element is always used to substitute the Al element.^[40–44] According to the elastic moduli criterion,^[45] the metallic glasses with the substitution of Al by Ga could have low T_{g} and unique mechanical and physical properties.^[40–44]

In this work, we report the formation of La–Ga–Cu bulk metallic glasses with low T_g and high glass-forming ability. By selecting appropriate minor additions of elements M (M represents a series of elements such as Co, Ni, Fe, Nb, Y, and Zr), the critical diameter of the full glassy rods of the La–Ga–Cu–M can be markedly enhanced to at least 5 mm. The characteristics and properties of these new LaGa-based BMGs are studied and compared.

2. Experiment

The ingots of the studied alloys in nominal composition of La–Ga–Cu and La–Ga–Cu–M (M = Co, Ni, Fe, Nb, Y, Si, and Zr) were prepared by arc melting the constituent elements in a Ti-gettered argon atmosphere. The cylindrical samples with the diameter of 2 mm, 3 mm, or 5 mm were fabricated by the copper mold casting method and listed in Table 1. The amorphous nature of the as-cast alloys was ascertained using x-ray diffraction (XRD) with a MAC M03 XHF diffractometer with Cu K_{α} radiation and high-resolution transmission electron microscopy (HRTEM) using a TECNAIF20 instrument operated at 200 kV. Thermal analysis was carried out using differential scanning calorimetry (DSC; Perkin-Elmer DSC-8000) at a heating rate of 20 K/min. The density was determined by the Archimedean technique with an accuracy of within 0.1%. Elastic constants of the BMGs, including Yong's modulus E, shear modulus G, Poisson's ratio v, and bulk modulus K were measured using resonant ultrasound spectroscopy (RUS).

^{*}Project supported by the National Natural Science Foundation of China (Grant Nos. 51571209 and 51461165101), the National Basic Research Program of China (Grant No. 2015CB856800), and the Key Research Program of Frontier Sciences, Chinese Academy of Sciences (Grant No. QYZDY-SSW-JSC017).

[†]Corresponding author. E-mail: hybai@iphy.ac.cn

 $[\]ensuremath{\mathbb{O}}$ 2017 Chinese Physical Society and IOP Publishing Ltd

Chin. Phys. B Vol. 26, No. 1 (2017) 018106

Composition	D/mm	$T_{\rm g}/{ m K}$	$T_{\rm x}/{ m K}$	$\Delta T_{\rm x}/{ m K}$	$T_{\rm m}/{\rm K}$	$T_{\rm l}/{\rm K}$	$T_{\rm rg}(T_{\rm g}/T_{\rm l})$	$\gamma[T_{\rm x}/(T_{\rm g}+T_{\rm l})]$	ho/g·cm ⁻³
La68Ga10Cu22	2	375	424	49	694	722	0.519	0.387	6.447
$La_{68}Ga_{12}Cu_{20} \\$	2	380	432	52	690	713	0.533	0.395	6.467
La68Ga14Cu18	2	391	435	44	691	715	0.547	0.393	6.437
La70Ga10Cu20	2	379	409	30	695	733	0.517	0.368	6.433
La70Ga12Cu18	3	382	438	56	687	720	0.531	0.397	6.431
La70Ga14Cu16	2	394	433	39	692	762	0.517	0.375	6.486
La70Ga16Cu14	2	401	452	51	685	727	0.552	0.401	6.391
La72Ga12Cu16	2	384	406	22	694	752	0.511	0.357	6.388
La72Ga14Cu14	3	388	450	62	681	735	0.528	0.401	6.441
La _{69.5} Ga ₁₂ Cu ₁₈ Co _{0.5}	> 5	394	482	88	685	704	0.560	0.439	6.426
La ₆₉ Ga ₁₂ Cu ₁₈ Co ₁	> 5	397	485	88	685	710	0.559	0.438	6.439
La ₆₈ Ga ₁₂ Cu ₁₈ Co ₂	> 5	398	480	82	685	714	0.557	0.432	6.452
La ₆₇ Ga ₁₂ Cu ₁₈ Co ₃	> 5	398	486	88	682	716	0.556	0.436	6.465
La ₆₆ Ga ₁₂ Cu ₁₈ Co ₄	> 5	402	487	85	683	725	0.554	0.432	6.483
La ₆₅ Ga ₁₂ Cu ₁₈ Co ₅	> 5	405	480	75	682	733	0.553	0.422	6.498
La ₆₈ Ga ₁₂ Cu ₁₈ Fe ₂	> 5	388	455	67	687	742	0.523	0.403	6.422
La68Ga12Cu18Ni2	> 5	400	472	72	690	725	0.552	0.420	6.447
La68Ga12Cu18Nb2	> 5	395	466	71	691	748	0.528	0.408	6.533
La68Ga12Cu18Si2	3	408	479	71	693	718	0.568	0.425	6.384
$La_{68}Ga_{12}Cu_{18}Zr_2$	> 5	392	471	79	685	710	0.552	0.427	6.435
$La_{68}Ga_{12}Cu_{18}Y_2$	> 5	387	448	61	684	706	0.548	0.410	6.416

Table 1. Thermal properties (heating rate 20 K/min) and room temperature density of LaGa-based MGs.

3. Results and discussion

Figure 1 shows the ternary phase diagram for the composition region of the La-Ga-Cu BMGs. Nine typical bulk glass alloys (filled circles), which can be quenched into a fully glassy state rod of 2-3 mm in diameter, are located in the region. One can see that BMGs with a wide composition range of 68-72 at.% La, 10-16 at.% Ga, and 14-22 at.% Cu can be easily prepared by the copper mold casting method. The La₇₀Ga₁₂Cu₁₈ and La₇₂Ga₁₄Cu₁₄BMGs are the best glass formers in present La-Ga-Cu alloys, the critical diameter can reach about 3 mm. Figure 2(a) shows the XRD patterns of the typical as-cast La-Ga-Cu samples, the broad diffraction maxima indicating the fully gassy structure of the alloys. Figure 2(b) presents the HRTEM image and selected-area electron diffraction (SAED) pattern (the inset image of Fig. 2(b)) of the as-cast La70Ga12Cu18 rod with a diameter of 3 mm. Both of the homogeneous contrast in the HRTEM image and only a broad halo ring in the SAED pattern confirm the amorphous structure of the alloy. Figure 3(a) shows that the DSC curves of the as-cast samples have distinct glass transition and sharp crystallization peaks, further confirming the amorphous structure.

From the DSC traces in Figs. 3(a) and 3(b), the T_g , the onset temperature of crystallization T_x , the melting temperature $T_{\rm m}$, the liquid temperature $T_{\rm l}$, and the supercooled liquid temperature range $\Delta T_{\rm x} = T_{\rm x} - T_{\rm g}$ of the ternary La–Ga–Cu BMGs are determined and listed in Table 1. As shown in Table 1 and Fig. 3(a), La₆₈Ga₁₀Cu₂₂ has the lowest $T_{\rm g}$ of 375 K among these ternary La–Ga–Cu BMGs, and the $T_{\rm g}$ increases from 379 K to 401 K with increasing Ga content from 10 at.% to 16 at.% in the La₇₀Ga_{10+x}Cu_{20-x} and La_{72-x}Ga₁₂Cu_{16+x} systems, indicating that lower Ga content or higher Cu content results in lower $T_{\rm g}$. Generally, the LaGa-based BMGs have exceptionally low $T_{\rm g}$ (375–401 K) close to that of many polymeric glasses such as PVC (348–378 K).^[46]



Fig. 1. (color online) Ternary phase diagram shows the composition region of La–Ga–Cu BMGs.



Fig. 2. (color online) (a) XRD patterns of the as-cast rods of La–Ga–Cu BMGs with the different diameters; (b) the HRTEM image and SAED pattern (the inset image) of the as-cast $La_{70}Ga_{12}Cu_{18}$ sample of 3 mm.



Fig. 3. (color online) DSC traces concentrated on the glass transition (a) and melting (b) for the typical La–Ga–Cu BMGs at a heating rate of 20 K/min.

Minor alloying addition has shown dramatic effects on glass formation and various properties of bulk metallic glasses.^[47-53] To further improve the GFA of ternary La₇₂Ga₁₀Cu₁₈ alloy, a series of elements with different atomic sizes were selected to add into the alloy. According to the atomic radius, these elements can be classified into three groups: large atoms (Goldschmidt radii: Y, 0.182 nm; Zr, 0.16 nm), intermediate atoms (Nb, 0.147 nm; Fe, 0.126 nm; Co, 0.125 nm; Ni, 0.125 nm), and small atoms (Si, 0.115 nm).^[47] Figure 4(a) shows the XRD patterns of the as-cast rods of $La_{70-x}Ga_{12}Cu_{18}Co_x$ (x = 0.5, 1, 2, 3, 4, 5) with the diameter of 5 mm, and figure 4(b) shows the XRD patterns of $La_{68}Ga_{12}Cu_{18}M_2$ (M = Fe, Co, Ni, Zr, Nb, Si, Y) BMGs with the different diameters. The XRD patterns of the as-cast alloys exhibit only broad diffraction peaks typical for an entirely amorphous structure. From the DSC traces in Fig. 5, the $T_{\rm g}$, $T_{\rm x}$, $T_{\rm m}$, $T_{\rm l}$, and $\Delta T_{\rm x} = T_{\rm x} - T_{\rm g}$ of the ternary La–Ga–Cu–M (M represents addition elements) BMGs are determined and listed in Table 1. Besides, the critical diameters D_c of the fully glassy La–Ga–Cu–*M* alloys are also listed in Table 1.



Fig. 4. (color online) XRD patterns of the as-cast rods of (a) $La_{70-x}Ga_{12}Cu_{18}Co_x$ (x = 0.5, 1, 2, 3, 4, 5) and (b) $La_{68}Ga_{12}Cu_{18}M_2$ (M = Fe, Co, Ni, Zr, Nb, Si, Y) BMGs with different diameters.

From Table 1, we find experimentally that both the large and the intermediate atoms even with minor addition have great positive effect on the GFA of the ternary $La_{72}Ga_{10}Cu_{18}$ alloys. Replacing 2 at.% La with Fe, Ni, Nb, Zr, or Y, the D_c of $La_{72}Ga_{10}Cu_{18}$ is drastically enhanced from 3 mm to at least 5 mm. For Co, even a minor addition of 0.5 at.% can greatly improve the GFA of $La_{72}Ga_{10}Cu_{18}$ from 2 mm to at least 5 mm. However, the small atoms have no obviously positive effect on GFA. Substituting 2% La with Si in $La_{72}Ga_{10}Cu_{18}$,

the GFA of $La_{72}Ga_{10}Cu_{18}$ is not obviously increased. These results are quite different from those of the previous studies, where more than 2% additions of Si in Cu-based alloys were detrimental to the GFA.^[54]



Fig. 5. (color online) DSC traces concentrated on the glass transition (a), (b) and melting (c), (d) for the typical La–Ga–Cu–M (M = Fe, Co, Ni, Zr, Nb, Si, Y) BMGs at a heating rate of 20 K/min.



Fig. 6. (color online) Relationship between the atomic radius and (a) the glass forming ability parameter γ and (b) thermal stability parameter ΔT_x . (c) Relationship between γ or ΔT_x and Co additive content.

Both of glass-forming ability and thermal stability are important parameters for machining in the supercooled liquid region. We choose the thermodynamic parameter $\gamma = T_x/(T_g + T_l)$ to characterize the GFA, and $\Delta T_x = T_x - T_g$ to characterize the thermal stability. Figures 6(a) and 6(b) show the effect of minor alloying on the GFA and thermal stability. We can find that after minor alloying, both γ and ΔT_x increase, which confirms that minor alloying is an effective method for improving the GFA and thermal stability of the alloy system. Figure 6(c) shows the effect of Co additive content on γ and ΔT_x . It can be seen that both γ and ΔT_x show a " Λ " shape relationship with the additive content. Such a phenomenon is rarely seen in the known metallic glasses and contrasts with previous findings that the beneficial addition of transition metals to improve GFA is usually higher than 3 at.%.^[42]

To further understand the mechanism of glass transition and evaluate the GFA of the La–Ga–Cu alloy, we study its crystallization behavior by using DSC. Figure 7 shows the DSC curves of the $La_{70}Ga_{12}Cu_{18}$ BMG at different heating rates. The crystallization peak shifts to higher temperature with increasing heating rate as shown in Fig. 7, indicating the obvious kinetic behavior of crystallization. The inset shows the dependence of T_g and T_x upon ϕ at different heating rates from 5 K/min to 160 K/min. The crystallization kinetics of the MGs can be evaluated by Kissinger's equation^[55]

$$\ln\frac{T^2}{\phi} = \frac{E_{\mathrm{a}}}{T} + \ln\frac{E_{\mathrm{a}}}{k_{\mathrm{B}}K_{\mathrm{0}}},$$

where *T* is the crystallization characteristic temperature, k_B is the Boltzman constant, K_0 is the frequency factor, and E_a is the apparent activation energy. From the data inset, the activation energy of crystallization is evaluated to be about 1.61 eV, which is fairly small compared with that of other MGs.^[56]



Fig. 7. (color online) DSC traces of La₇₀Ga₁₂Cu₁₈ BMG at different heating rates from 5 K/min to 80 K/min. The inset shows the Kissenger plot of T_x and VFT relationship between T_g and ϕ .

Fragility shows the intrinsic features of the supercooled liquid and can be used to classify glass-forming liquid into three general categories: strong, intermediate, and fragile. The fragility can be quantified by the fragility parameter m defined as^[57]

$$m = \frac{\mathrm{d}\log\langle \tau \rangle}{\mathrm{d}l \langle T_{\mathrm{g}}/T \rangle} \bigg|_{T=T_{\mathrm{g}}}$$

where $\langle \tau \rangle$ is the average relaxation time, and *T* is the temperature. From the VFT fit, the *m* at a particular *T*_g can be calculated from^[58]

$$m = \frac{DT_0T_{\rm g}}{(T_{\rm g} - T_0)^2\ln 10}.$$

From the data inset, the fragility *m* can be evaluated to be about 38 ± 1 , which is very close to the strong limit and similar to that of Pr-, La-, Tm-, and Mg-based MGs.^[56,59]

A lot of features and properties of metallic glasses correlate remarkably well with the elastic modulus.^[60,61] We also study the elastic properties of LaGa-based BMGs by using the resonant ultrasound spectroscopy (RUS) and the results are shown in Table 2. Figure 8(a) shows the various BMGs in the form of Poisson's ratio versus fragility of the glass-forming liquid. There is a clear linear relationship between *m* and possion's ratio, which is matched with the results of Novikov.^[60] Figure 8(b) shows the various BMGs in the form of T_g versus *E*. There is a clear linear relationship between T_g and *E*. From the data in Fig. 8(b), we confirm that the obtained LaGa-based BMGs have lower elastic modulus and lower T_g compared with other BMGs.

Table 2. The elastic constants of La-Cu-Ga-M MGs.

E/GPa	G/GPa	K/GPa	γ
31.9	11.8	40.8	0.352
32.2	11.9	40.5	0.353
32.7	12.1	41.5	0.351
31.5	11.6	40.4	0.357
31.9	11.8	40.1	0.352
32.6	12.1	41.8	0.347
32.7	12.2	41.2	0.341
31.4	11.5	39.8	0.365
32.3	11.9	41.3	0.357
32.1	11.9	40.3	0.349
32.2	11.9	40.5	0.353
32.4	12.0	40.7	0.350
32.6	12.1	40.9	0.347
32.7	12.1	41.0	0.351
32.8	12.1	41.2	0.355
33.4	12.3	41.6	0.358
33.4	12.4	41.2	0.347
32.9	12.2	40.9	0.348
32.2	11.9	40.3	0.353
32.5	12.1	40.5	0.343
32.3	12.0	40.4	0.346
	<i>E/GPa</i> 31.9 32.2 32.7 31.5 31.9 32.6 32.7 31.4 32.3 32.1 32.2 32.4 32.6 32.7 32.8 33.4 33.4 32.9 32.2 32.5 32.3	E/GPa G/GPa 31.9 11.8 32.2 11.9 32.7 12.1 31.5 11.6 31.9 11.8 32.7 12.1 31.5 11.6 31.9 11.8 32.6 12.1 32.7 12.2 31.4 11.5 32.3 11.9 32.1 11.9 32.2 11.9 32.1 11.9 32.2 11.9 32.4 12.0 32.6 12.1 32.7 12.1 32.8 12.1 32.4 12.0 32.5 12.1 33.4 12.3 33.4 12.4 32.9 12.2 32.2 11.9 32.5 12.1 32.5 12.1 32.3 12.0	E/GPa G/GPa K/GPa 31.911.840.832.211.940.532.712.141.531.511.640.431.911.840.132.612.141.832.712.241.231.411.539.832.311.941.332.111.940.332.211.940.532.412.040.732.612.141.032.812.141.233.412.341.633.412.441.232.912.240.932.211.940.332.512.140.532.412.040.7



Fig. 8. (color online) (a) A linear relationship between the fragility *m* of metallic glass-forming liquids and the Poisson's ratio of BMGs. (b) A linear relationship between T_g and *E*.

4. Conclusion

In summary, we report the formation of LaGa-based bulk metallic glasses with extremely low T_g , high glass-forming ability, wide supercooled liquid region, high stability, and good properties. The LaGa-based MGs with excellent glass formation ability and extremely low glass transition temperatures could have potential applications in micromachining field.

Acknowledgement

We thank D. Q. Zhao, M. X. Pan, and B. B. Wang for the experimental assistance.

References

- [1] Johnson W L 1999 MRS Bull. 24 42
- [2] Inoue A 2000 Acta Mater. 48 279
- [3] Wang W H, Dong C and Shek C H 2004 Mater. Sci. Eng. R. 44 45
- [4] Greer A L and Ma E 2007 *MRS Bull.* **32** 611
- [5] Inoue A and Zhang T 1996 Mater. Trans. JIM 37 185
- [6] Peker A and Johnson W L 1993 Appl. Phys. Lett. 63 2342
- [7] He Y, Schwarz R B and Archuleta J I 1996 Appl. Phys. Lett. 69 1861
- [8] Drehman A J, Greer A L and Turnbull D 1982 Appl. Phys. Lett. 41 716
- [9] Ponnambalam V, Poon S J, Shiflet G J, Keppens V M, Taylor R and Petculescu G 2003 Appl. Phys. Lett. 83 1131
- [10] Lu Z P, Liu C T and Porter W D 2003 Appl. Phys. Lett. 83 2581
- [11] Wang X, Yoshii I, Inoue A, Kim Y H and Kim I B 1999 Mater. Trans. JIM 40 1130
- [12] Yi S, Park T G and Kim D H 2000 J. Mater. Res. 15 2425
- [13] Guo F Q, Wang H J, Poon S J and Shiflet G J 2005 Appl. Phys. Lett. 86 091907
- [14] Lin X H and Johnson W L 1995 J. Appl. Phys. 78 6514
- [15] Tang M B, Zhao D Q, Pan M X and Wang W H 2004 Chin. Phys. Lett. 21 901
- [16] Wu N C, Zuo L, Wang J Q and Ma E 2016 Acta Mater. 108 143
- [17] Xi X K, Wang R J, Zhao D Q, Pan M X and Wang W H 2004 J. Non-Cryst. Solids 344 105
- [18] Si J J, Wang T, Wu Y D, Cai Y H, Chen X H, Wang W Y, Liu Z K and Hui X D 2015 Appl. Phys. Lett. 106 251905
- [19] Huang H G, Ke H B, Wang Y M, Pu Z, Zhang P, Zhang P G and Liu T W 2016 J. Alloys Compd. 684 75
- [20] Zhang B, Pan M X, Zhao D Q and Wang W H 2004 Appl. Phys. Lett. 85 61
- [21] Zhang B, Zhao D Q, M X Pan, W H Wang and Greer A L 2005 Phys. Rev. Lett. 94 205502
- [22] Zhang B, Zhao D Q, Pan M X, Wang R J and Wang W H 2006 Acta Mater. 54 3025
- [23] Li S, Wang R J, Pan M X, Zhao D Q and Wang W H 2005 Scr. Mater. 53 1489
- [24] Jiang Q K, Zhang G Q, Chen LY, Wu J Z, Zhang H G and Jiang J Z 2006 J. Alloys Compd. 424 183

- [25] Li R, Pang S, Men H, Ma C and Zhang T 2006 Scr. Mater. 54 1123
- [26] Xi X K, Li S, Wang R J, Zhao D Q, Pan M X and Wang W H 2005 J. Mater. Res. 20 2243
- [27] Wu J, Wang Q, Chen F, Wang Y M, Qiang J B and Dong C 2007 Intermetallics 15 652
- [28] Li S, Wang R J, Pan M X, Zhao D Q and Wang W H 2008 J. Non-Cryst. Solids 354 1080
- [29] Yu H B, Yu P, Wang W H and Bai H Y 2008 Appl. Phys. Lett. 92 141906
- [30] Zhao Z F, Wen P, Wang R J, Zhao D Q, Pan M X and Wang W H 2006 J. Mater. Res. 21 369
- [31] Wang J Q, Wang W H and Bai H Y 2009 Appl. Phys. Lett. 94 041910
- [32] Ding D, Wang P, Guan Q, Tan M B and Xia L 2013 Chin. Phys. Lett. 30 096104
- [33] Wu C, Ding D and Xia L 2016 Chin. Phys. Lett. 33 016102
- [34] Kumar G, Tang H X and Schroers J 2009 Nature 457 868
- [35] Zhao K, Xia X X, Bai H Y, Zhao D Q and Wang W H 2011 Appl. Phys. Lett. 98 141913
- [36] Zhao K, Li J F, Zhao D Q, Pan M X and Wang W H 2009 Scr. Mater. 61 1091
- [37] Zhao K, Liu K S, Li J F, Wang W H and Jiang L 2009 Scr. Mater. 60 225
- [38] Jiao W, Zhao K, Xi X K, Zhao D Q, Pan M X and Wang W H 2010 J. Non-Cryst. Solids 356 1867
- [39] Zhang W, Guo H, Chen M W, Saotome Y, Qin C L and Inoue A 2009 Scr. Mater. 61 744
- [40] Xu B C, Xue R J and Zhang B 2013 Intermetallics 32 1
- [41] Xue, R J Zhao L Z, Zhang B, Bai H Y, Wang W H and Pan M X 2015 Appl. Phys. Lett. 107 241902
- [42] Singh D, Mandal R K, Srivastava O N and Tiwari R S 2015 J. Non-Cryst. Solids 427 98
- [43] Yadav T P, Singh D, Shahi R R, Shaz M A, Tiwari R S and Srivastava O N 2011 Philos. Mag. 91 2474
- [44] Fremy M A, Gignoux D, Schmitt D and Takeuchi A Y 1989 J. Magn. Magn. Mater. 82 175
- [45] Wang W H 2009 Adv. Mater. 21 4524
- [46] Cardarelli F 2000 Materials Handbook (London: Springer)
- [47] Wang W H, Bian Z, Wen P, Zhang Y, Pan M X and Zhao D Q 2002 Intermetallics 10 1249
- [48] Lu Z P and Liu C T 2004 J. Mater. Sci. 39 3965
- [49] Liu C T and Lu Z P 2005 Intermetallics 13 415
- [50] Wang W H 2007 Prog. Mater. Sci. 52 540
- [51] Park E S, Chang H J, Kyeong J S and Kim D H 2008 J. Mater. Res. 23 1995
- [52] Chen N, Martin L, Luzguine-Luzgin D V and Inoue A 2010 Materials 3 5320
- [53] Miracle D B, Sanders W S and Senkov O N 2003 Philos. Mag. 83 2409
- [54] Yim H C, Busch R and Johnson W L 1998 J. Appl. Phys. 83 7993
- [55] Kissinger H E 1956 J. Res. Natl. Bur. Stand. 57 217
- [56] Zhang B, Wang R J, Zhao D Q, Pan M X and Wang W H 2004 *Phys. Rev. B* 70 224208
- [57] Böhmer R and Angell C A 1992 Phys. Rev. B 45 10091
- [58] Böhmer R, Ngai K L, Angell C A and Plazek D J 1993 J. Chem. Phys. 99 4201
- [59] Novikov V N and Sokolov A P 2006 Phys. Rev. B 74 064203
- [60] Wang W H 2012 Prog. Mater. Sci. 57 487
- [61] Wang W H 2006 J. Appl. Phys. 99 093506